EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	136	(@ad<"20020506") and "156"/\$.ccls. and (caps or lids or sinks) and wafer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/01 22:35
L2	124	L1 and ("si" or silicon or semiconductor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/01 22:24
L3	55	("5824177").URPN.	USPAT	OR	OFF	2006/10/01 22:26
L4	1079	(@ad<"20020506") and ((caps or lids or sinks) same wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/01 22:41
	347	L4 and ((tool or aparatus or assembly or mold or plate) same ("si" or semiconductor or silicon))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	-2006/10/01 22:41
L6	328	L5 not L2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/01 22:37
L7	732	L4 not L5	US-PGPUB;	OR	OFF	2006/10/01 22:37
		하기 열리하기 의료되었다는 경우 함께를 가득하고 주요년 	USPAT; USOCR;			
a di ta	The source of the source	(2) (4) (4) (4) (4) (4) (4) (4) (4) (4) (4	EPO; JPO;			
		・	DERWENT; IBM_TDB			
L8	20	L4 and 438/53,106.ccls.	US-PGPUB;	OR	OFF	2006/10/01 22:38
_ _		3	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB			2000, 10, 01 22.50
L9	0	("20040170825").PN	USPAT; USOCR	OR	OFF	2006/10/01 22:39
L10	1	("20040170825").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/10/01 22:39

EAST Search History

L11	6133	(@ad<"20020506") and ((covers or caps or lids or sinks) same wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/01 22:41
L12	3213	(@ad<"20020506") and ((covers or caps or lids or sinks) with wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/01 22:41
L13	928	L12 and ((tool or aparatus or assembly or mold or plate) same ("si" or semiconductor or silicon))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/01 22:43
		L12 and 2357/704.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/01 22:42
L15	15	L12 and 257/704.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/01 22:43
L16	129	L12 and "156"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/01 22:43
L17	52	L16 and ((tool or aparatus or assembly or mold or plate) same ("si" or semiconductor or silicon))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/01 22:43

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